

Technical Data Sheet

424/T2C9-1FJA

Features

- Popular T-1 3/4 colorless package
- High luminous power.
- Typical chromaticity coordinates $x=0.29$, $y=0.28$ according to CIE1931.
- Available on tape and reel.
- ESD-withstand voltage: up to 4KV .
- The product itself will remain within RoHS compliant version



Descriptions

- The series is designed for application required high luminous intensity.
- The phosphor filled in the reflector converts the blue emission of InGaN chip to ideal white.

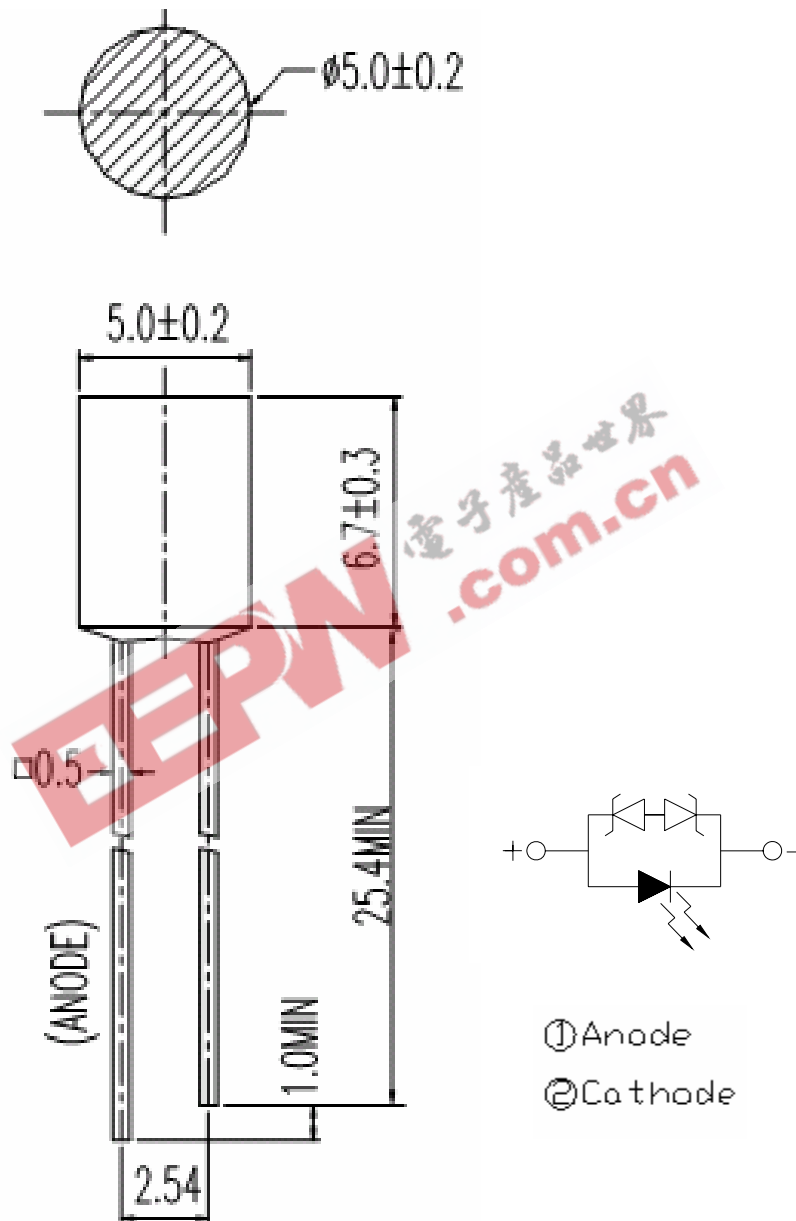
Applications

- Message panels
- Optical Indicators
- Backlighting
- Marker Lights

Device Selection Guide

| LED Part No. | Chip Material | Emitted Color | Lens Color |
|---------------|---------------|---------------|-------------|
| 424/T2C9-1FJC | InGaN | White | Water Clear |

Package Dimensions



Notes:

1. All dimensions are in millimeters, and tolerance is 0.25mm except being specified.
2. Lead spacing is measured where the lead emerges from the package.
3. Protruded resin under flange is 1.5mm Max. LED.

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Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|------------------|------------|------|
| Continuous Forward Current | I _F | 30 | mA |
| Peak Forward Current(Duty /10 @ 1KHZ) | I _{FP} | 100 | mA |
| Reverse Voltage | V _R | 5 | V |
| Operating Temperature | T _{opr} | -40 ~ +85 | °C |
| Storage Temperature | T _{stg} | -40 ~ +100 | °C |
| Soldering Temperature (T=5 sec) | T _{sol} | 260 ± 5 | °C |
| Power Dissipation | P _d | 100 | mW |
| Zener Reverse Current | I _Z | 100 | mA |
| Electrostatic Discharge | ESD | 4K | V |

Notes: Soldering time \leq 5 seconds.

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Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Units |
|--------------------------|----------------|----------------------|------|------|------|-------|
| Forward Voltage | V _F | I _F =20mA | 2.8 | -- | 3.6 | V |
| Zener Reverse Voltage | V _Z | I _Z =5mA | 5.2 | -- | -- | V |
| Reverse Current | I _R | V _R =5V | -- | -- | 50 | μA |
| Luminous Intensity | I _v | I _F =20mA | 360 | 550 | 1125 | mcd |
| Viewing Angle | 2θ 1/2 | I _F =20mA | -- | 95 | -- | deg |
| Chromaticity Coordinates | x | I _F =20mA | -- | 0.29 | -- | |
| | y | | -- | 0.28 | -- | |

Luminous Intensity Combination (mcd at 20mA)

| I _v Ranks | F | G | H | J |
|----------------------|-----|-----|-----|------|
| Min. | 450 | 565 | 715 | 900 |
| Max. | 565 | 715 | 900 | 1125 |

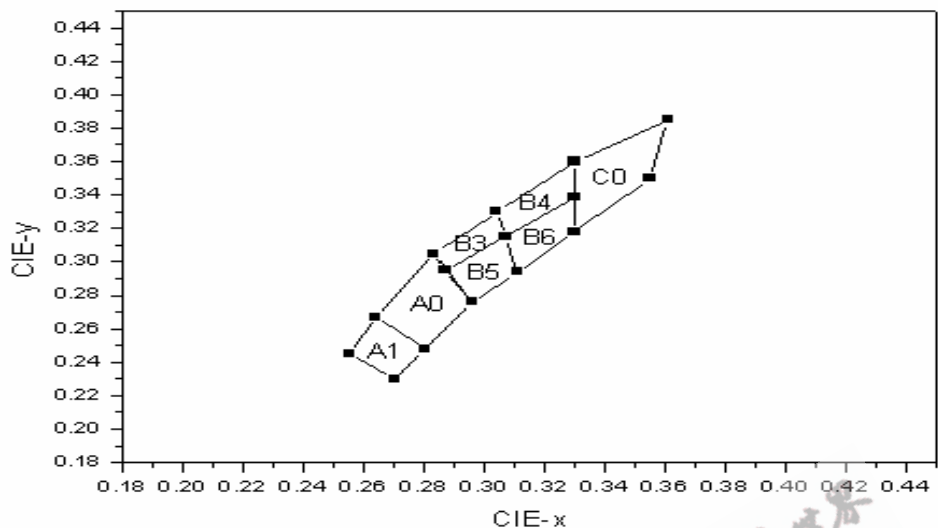
*Measurement Uncertainty of Luminous Intensity: ±15%

Forward Voltage Combination (V at 20mA)

| Group | A | | | |
|-------|------|------|------|------|
| Rank | 0 | 1 | 2 | 3 |
| Min. | 2.80 | 3.00 | 3.20 | 3.40 |
| Max. | 3.00 | 3.20 | 3.40 | 3.60 |

*Measurement Uncertainty of Forward Voltage : ±0.1V

CIE Chromaticity Diagram

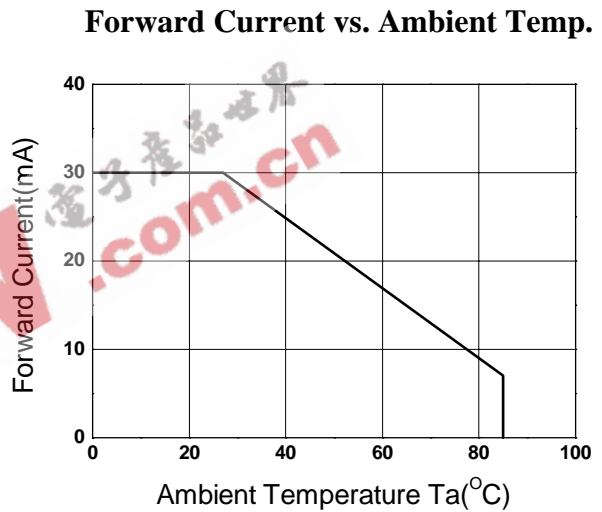
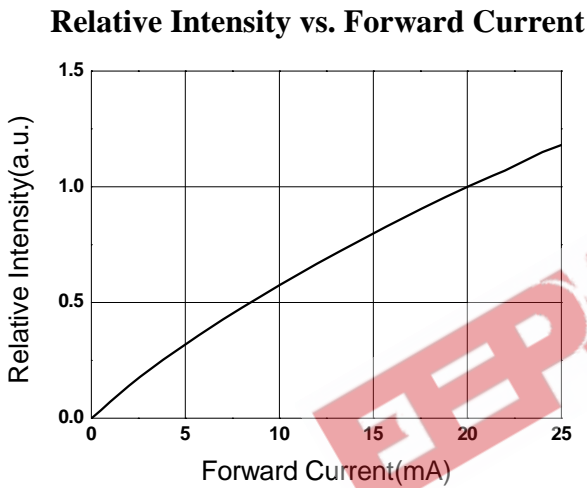
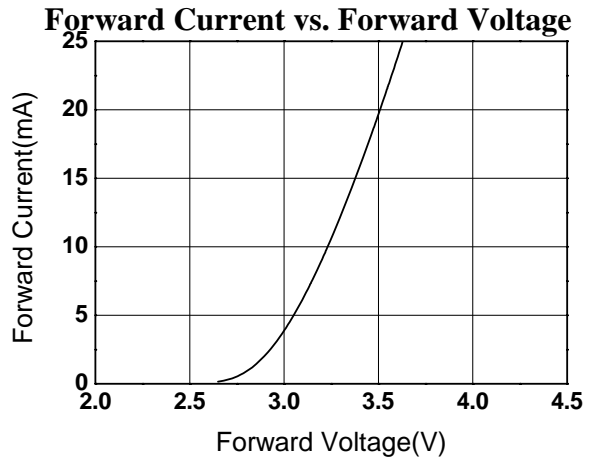
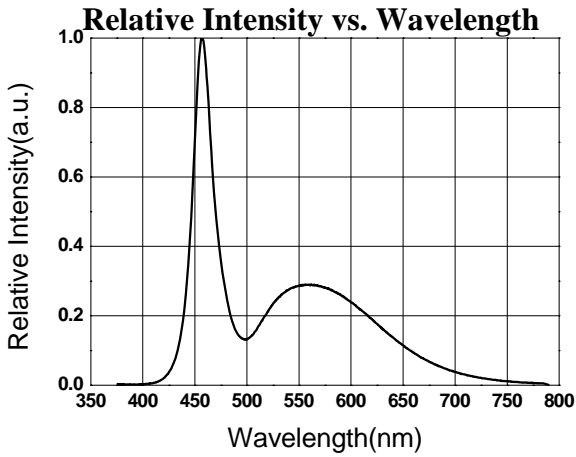


Color Ranks (IF=20mA , Ta=25°C)

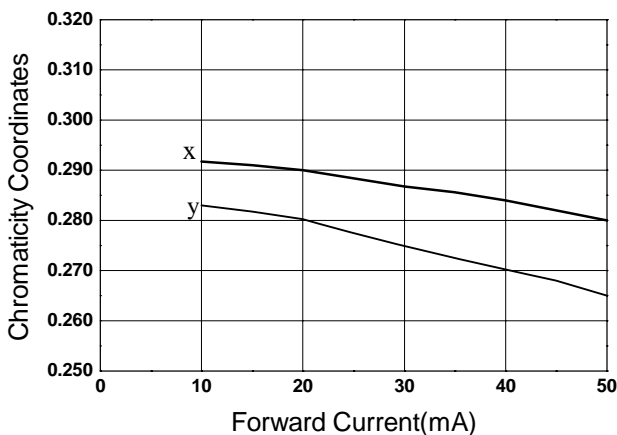
| Color Ranks | | CIE | | | |
|-------------|---|-------|-------|-------|-------|
| A1 | X | 0.255 | 0.264 | 0.28 | 0.27 |
| | Y | 0.245 | 0.267 | 0.248 | 0.23 |
| A0 | X | 0.264 | 0.283 | 0.296 | 0.28 |
| | Y | 0.267 | 0.305 | 0.267 | 0.248 |
| B3 | X | 0.283 | 0.304 | 0.307 | 0.287 |
| | Y | 0.305 | 0.33 | 0.315 | 0.295 |
| B4 | X | 0.304 | 0.33 | 0.33 | 0.307 |
| | Y | 0.33 | 0.36 | 0.339 | 0.315 |
| B5 | X | 0.287 | 0.307 | 0.311 | 0.296 |
| | Y | 0.295 | 0.315 | 0.294 | 0.276 |
| B6 | X | 0.307 | 0.33 | 0.33 | 0.311 |
| | Y | 0.315 | 0.339 | 0.318 | 0.294 |
| C0 | X | 0.33 | 0.361 | 0.355 | 0.33 |
| | Y | 0.36 | 0.385 | 0.35 | 0.318 |

※Measurement uncertainty of the color coordinates : ±0.01

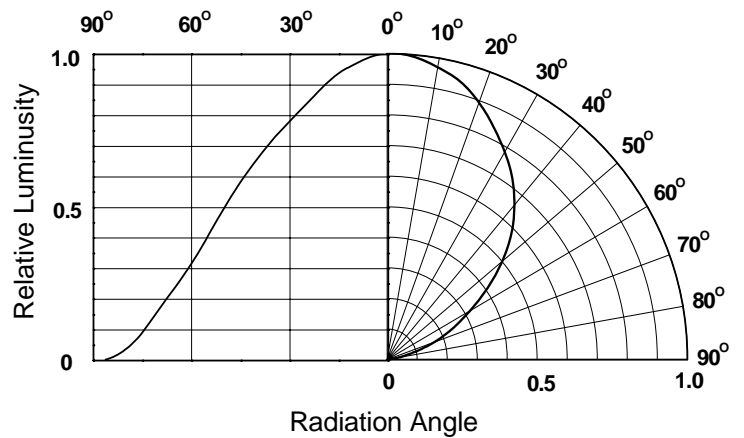
Typical Electro-Optical Characteristics Curves



Chromaticity Coordinate vs. Forward Current



Relative Intensity vs. Angle Displacement








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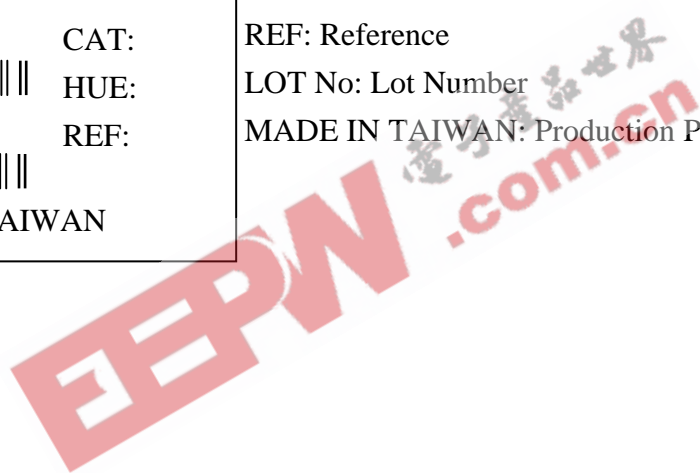
Packing Quantity Specification

- 1. 500PCS/1Bag , 5Bags/1Box
- 2. 10Boxes/1Carton

Label Form Specification

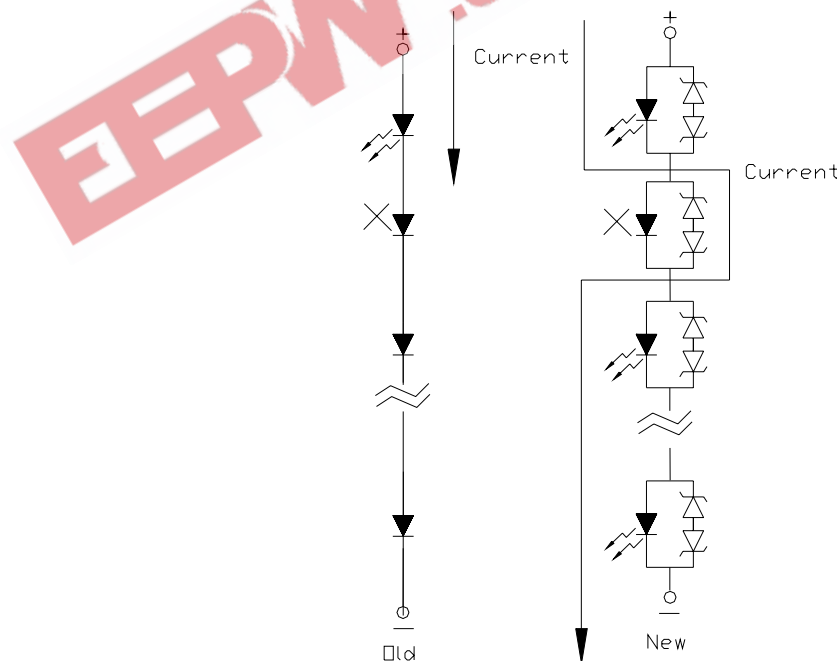
| | |
|---|------|
| EVERLIGHT | |
| CPN: | |
| P/N: | |
|  | RoHS |
| 424/T2C9-1FJA | |
| QTY : | CAT: |
|  | HUE: |
| LOT NO : | REF: |
|  | |
| MADE IN TAIWAN | |

CPN: Customer's Production Number
 P/N : Production Number
 QTY: Packing Quantity
 CAT: Ranks of Luminous Intensity and Forward Voltage
 HUE: Color Rank
 REF: Reference
 LOT No: Lot Number
 MADE IN TAIWAN: Production Place



Notes

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.
4. Below the zener reference voltage V_z , all the current flows through LED and as the voltage rises to V_z , the zener diode "breakdown." If the voltage tries to rise above V_z current flows through the zener branch to keep the voltage at exactly V_z .
5. When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light up



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6. Soldering Condition

Careful attention should be paid during soldering. When soldering, leave more than 3mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

Recommended soldering conditions:

| Hand Soldering | | DIP Soldering | |
|----------------------|-------------------------------------|---------------|--------------------------|
| Temp. at tip of iron | 400°C Max. (30W Max.) | Preheat temp. | 100°C Max. (60 sec Max.) |
| Soldering time | 3 sec Max. | Bath temp. | 265 Max. |
| Distance | 3mm Min.(From solder joint to case) | Bath time. | 5 sec Max. |
| | | Distance | 3mm Min. |



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